PAM2305

1A Step-Down DC-DC Converters

Features

- Efficiency up to 96%
- Only 40μA(TYP.) Quiescent Current
- Output Current: Up to 1A
- Internal Synchronous Rectifier
- 1.5MHz Switching Frequency
- Soft Start
- Under-Voltage Lockout
- Short Circuit Protection
- Thermal Shutdown
- 5-pin Small SOT23-5, DFN2x2 6-Pin and QFN3x3 16-Pin Packages
- Pb-Free Package

Applications

- Cellular Phone
- Portable Electronics
- Wireless Devices
- Cordless Phone
- Computer Peripherals
- Battery Powered Widgets
- Electronic Scales
- Digital Frame

General Description

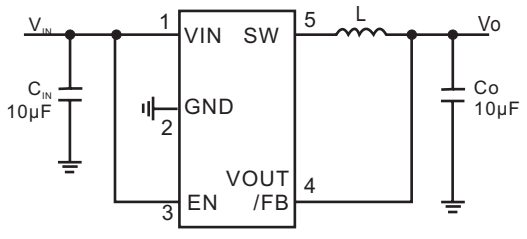
The PAM2305 is a step-down current-mode, DC-DC converter. At heavy load, the constant-frequency PWM control performs excellent stability and transient response. To ensure the longest battery life in portable applications, the PAM2305 provides a power-saving Pulse-Skipping Modulation (PSM) mode to reduce quiescent current under light load operation to save power.

The PAM2305 supports a range of input voltages from 2.5V to 5.5V, allowing the use of a single Li+/Li-polymer cell, multiple Alkaline/NiMH cell, USB, and other standard power sources. The output voltage is adjustable from 0.6V to the input voltage, while the part number suffix PAM2305-XX indicates pre-set output voltage of 3.3V, 2.8V, 2.5V, 1.8V, 1.5V, 1.2V or adjustable. All versions employ internal power switch and synchronous rectifierfor to minimize external part count and realize high efficiency. During shutdown, the input is disconnected from the output and the shutdown current is less than 0.1μA. Other key features include under-voltage lockout to prevent deep battery discharge.

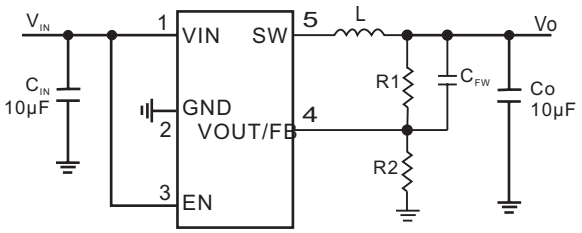
The PAM2305 is available in SOT23-5, DFN2x2 6-Pin and QFN3x3 16-Pin packages.

Typical Application

Fixed Output Voltage

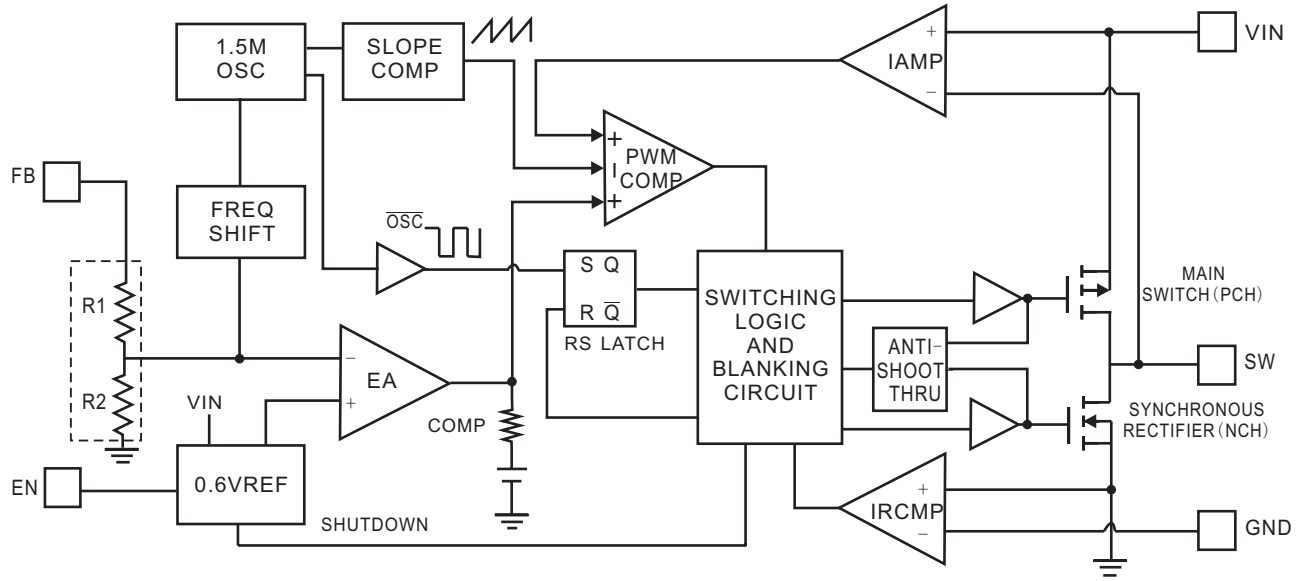


Adjustable Output Voltage



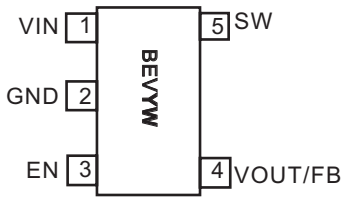
$$Vo = 0.6 \times \left(1 + \frac{R1}{R2}\right)$$

Block Diagram

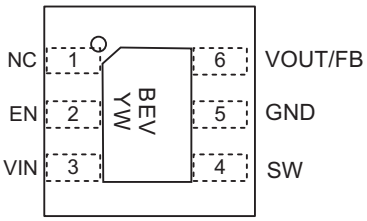


Pin Configuration& Marking Information

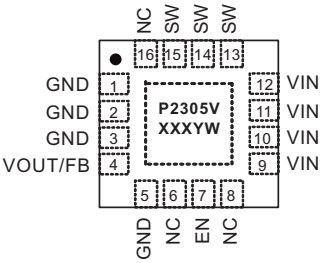
Top View
SOT23-5



Top View
DFN 2x2 6L



Top View
QFN 3x3 16L



BE: Product Code of PAM2305
V: Output Voltage
Y: Year
W: Week
X: Internal Code

Pin Description

Name	Function
VIN	Chip main power supply pin
GND	Ground
EN	Enable control input. Force this pin voltage above 1.5V, enables the chip, and below 0.3V shuts down the device.
VOUT/FB	VOUT: Output voltage feedback pin, an internal resistive divider divides the output voltage down for comparison to the internal reference voltage. FB: Feedback voltage to internal error amplifier, the threshold voltage is 0.6V.
SW	The drains of the internal main and synchronous power MOSFET.
NC	No connection

Absolute Maximum Ratings

These are stress ratings only and functional operation is not implied. Exposure to absolute maximum ratings for prolonged time periods may affect device reliability. All voltages are with respect to ground.

Input Voltage.....-0.3V to 6.6V
EN, FB Pin Voltage.....-0.3V to V_{IN}
SW Pi n Voltage.....-0.3V to (V_{IN}+0.3V)
Junction Temperature.....125°C
Storage Temperature Range.....-65°C to 150°C
Soldering Temperature.....300°C, 5sec

Recommended Operating Conditions

Supply Voltage.....2.5V to 5.5V
Max. Supply Voltage (for Max. duration of 30 minutes).....6.0V
Ambient Temperature Range.....-40°C to 85°C

Thermal Information

Parameter	Package	Symbol	Maximum	Unit
Thermal Resistance (Junction to Case)	SOT23-5[Note]	θ_{JC}	130	°C/W
	DFN 2x2		20	
	QFN 3x3		12	
Thermal Resistance (Junction to Ambient)	SOT23-5	θ_{JA}	102	
	DFN 2x2		68	
	QFN 3x3		34	
Internal Power Dissipation	SOT23-5	P_D	400	mW
	DFN 2x2		980	
	QFN 3x3		1470	

Note:
The maximun output current for SOT23-5 package is limited by internal power dissipation capacity as described in Application Information hereinafter.

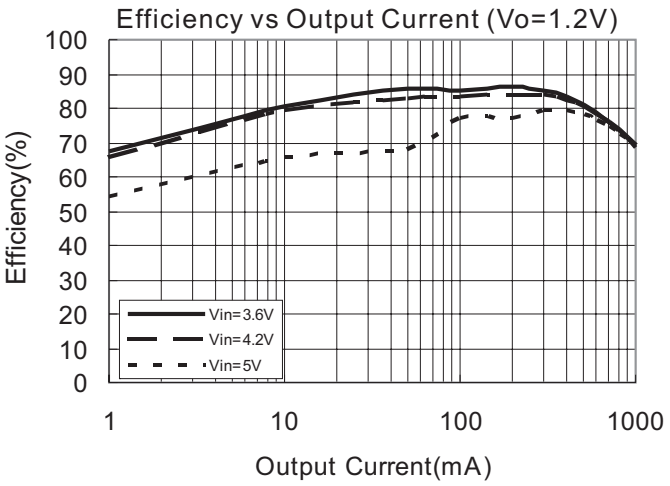
Electrical Characteristic

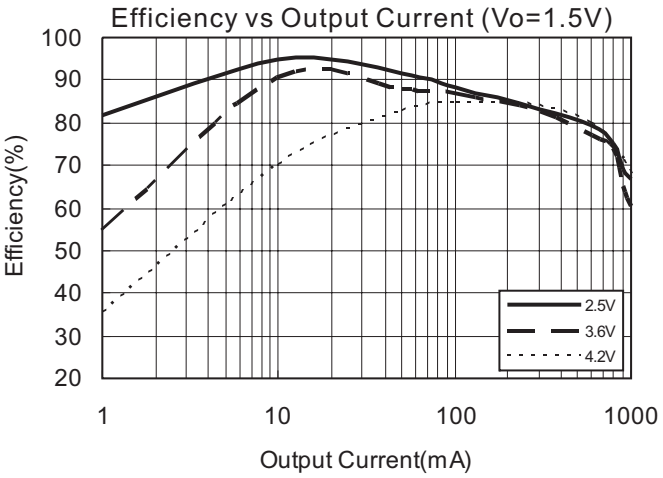
T_A=25°C, V_{IN}=3.6V, V_O=1.8V, C_{IN}=10µF, C_O=10µF,L=4.7µH, unless otherwise noted.

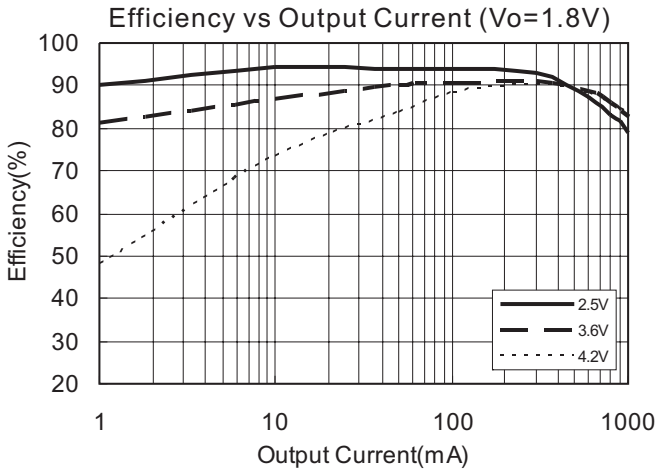
PARAMETER	SYMBOL	Test Conditions		MIN	TYP	MAX	UNITS
Input Voltage Range	V_{IN}			2.5		5.5	V
Regulated Feedback Voltage	V_{FB}			0.588	0.6	0.612	V
Reference Voltage Line Regulation	ΔV_{FB}				0.3		%/V
Regulated Output Voltage Accuary	V_O	I_O = 100mA		-3		+3	%
Peak Inductor Current	I_{PK}	V_{IN}=3V,V_{FB} = 0.5V or V_O=90%			1.5		A
Output Voltage Line Regulation	LNR	V_{IN} = 2.5V to 5V, I_O=10mA			0.2	0.5	%/V
Output Voltage Load Regulation	LDR	I_O=1mA to 800mA			0.5	1.5	%
Quiescent Current	I_Q	No load			40	70	µA
Shutdown Current	I_{SD}	V_{EN} = 0V			0.1	1	µA
Oscillator Frequency	f_{OSC}	V_O = 100%		1.2	1.5	1.8	MHz
		V_{FB} = 0V or V_O = 0V			500		kHz
Drain-Source On-State Resistance	$R_{DS(ON)}$	I_{DS}=100mA	P MOSFET		0.3	0.45	Ω
			N MOSFET		0.35	0.5	Ω
SW Leakage Current	I_{LSW}				±0.01	1	µA
High Efficiency	η				96		%
EN Threshold High	V_{EH}			1.5			V
EN Threshold Low	V_{EL}					0.3	V
EN Leakage Current	I_{EN}				±0.01		µA
Over Temperature Protection	OTP				150		°C
OTP Hysteresis	OTH				30		°C

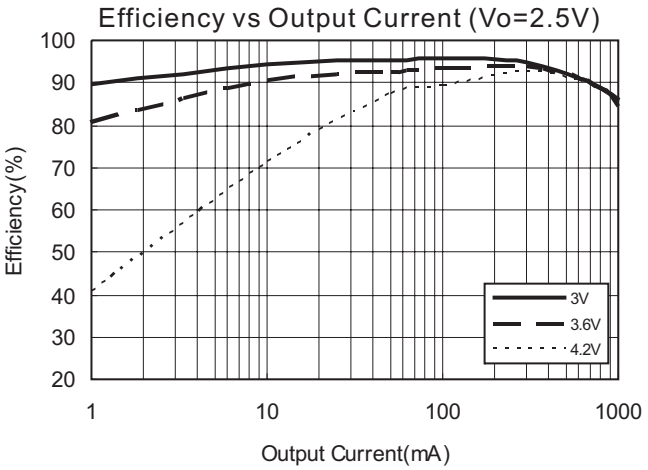
Typical Performance Characteristics

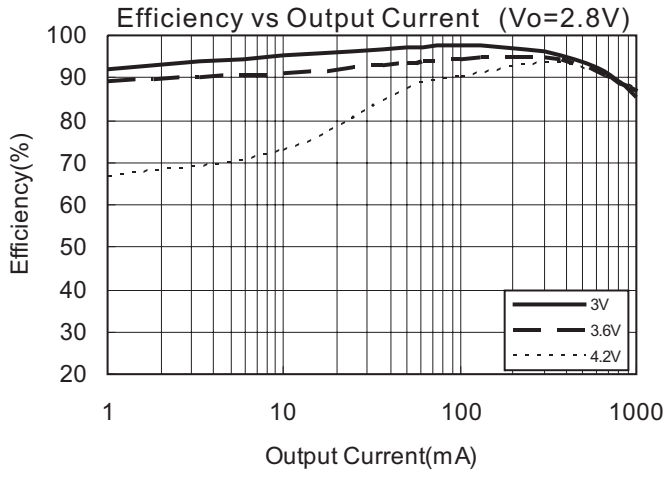
T_A=25°C, C_{IN}=10µF, C_O=10uF, L=4.7µH, unless otherwise noted.

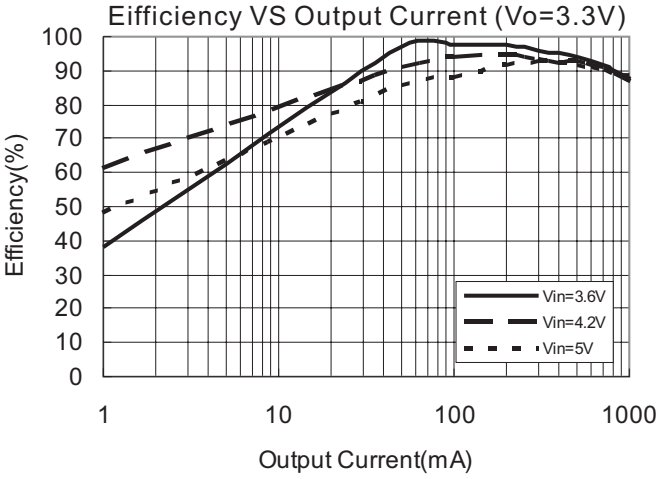












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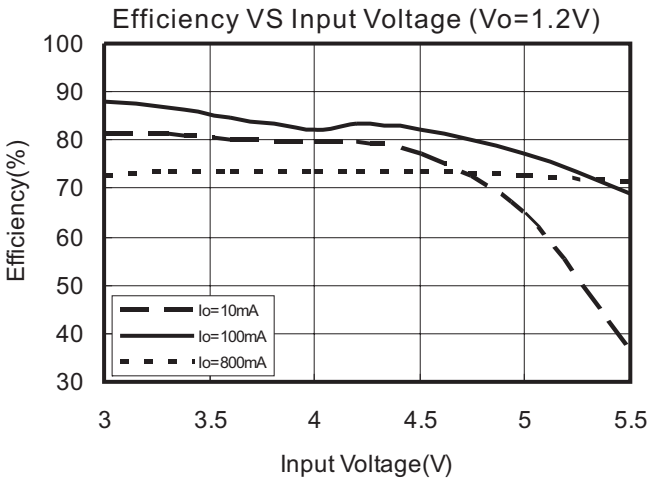
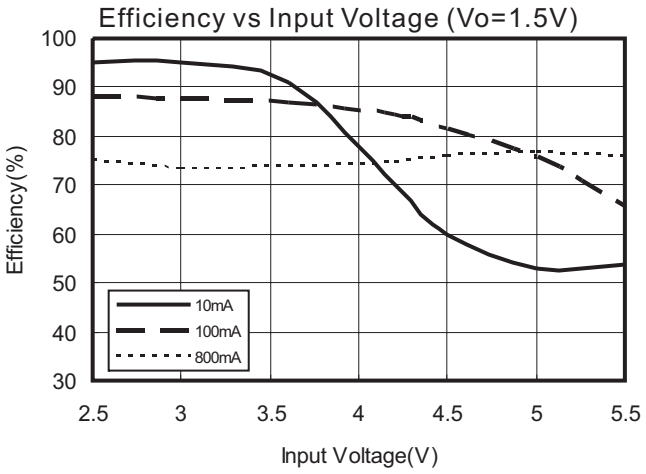
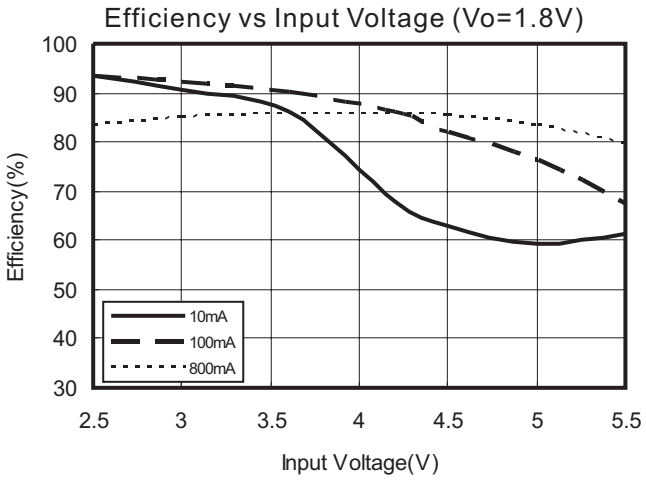
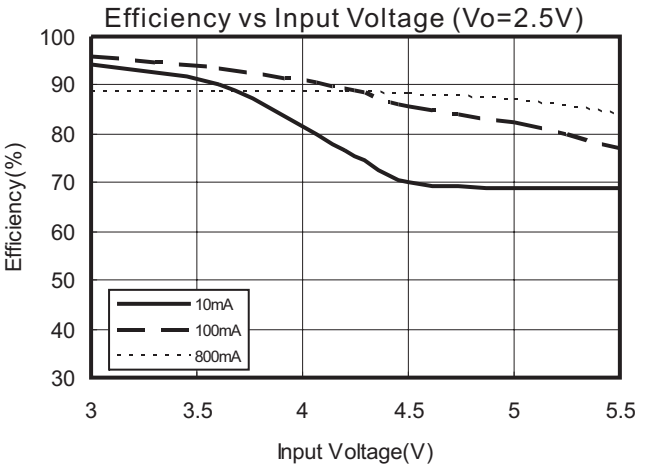
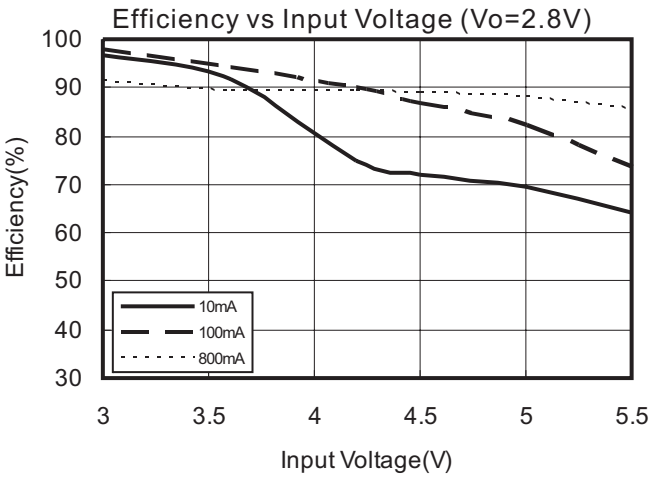
T_A=25°C, C_{IN}=10µF, C_O=10uF, L=4.7µH, unless otherwise noted.

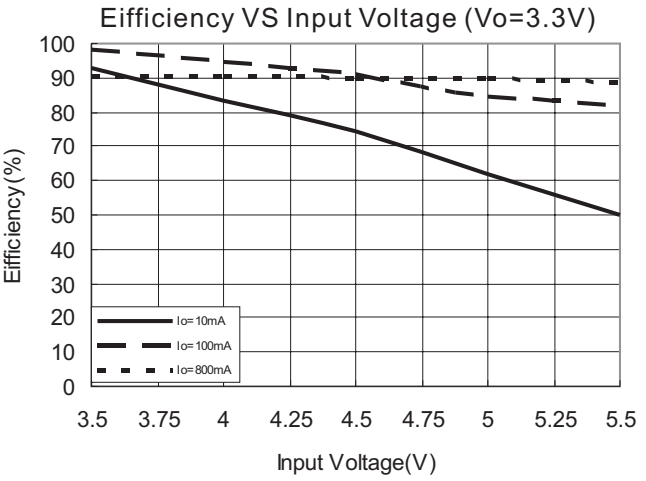








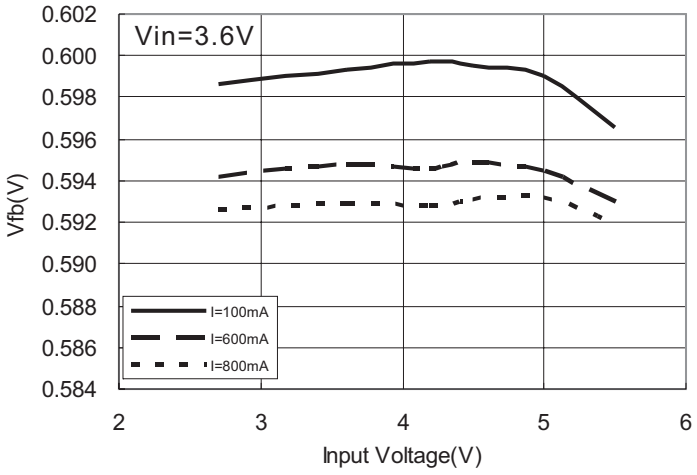




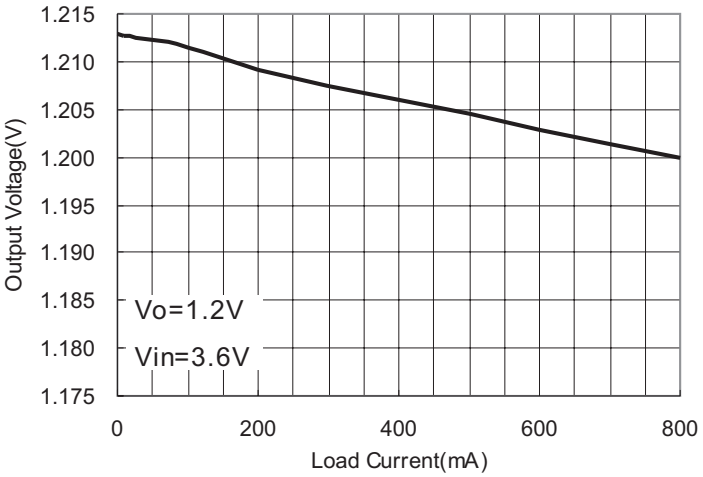
Typical Performance Characteristics

T_A=25°C, C_{IN}=10µF, C_O=10uF,L=4.7µH, unless otherwise noted.

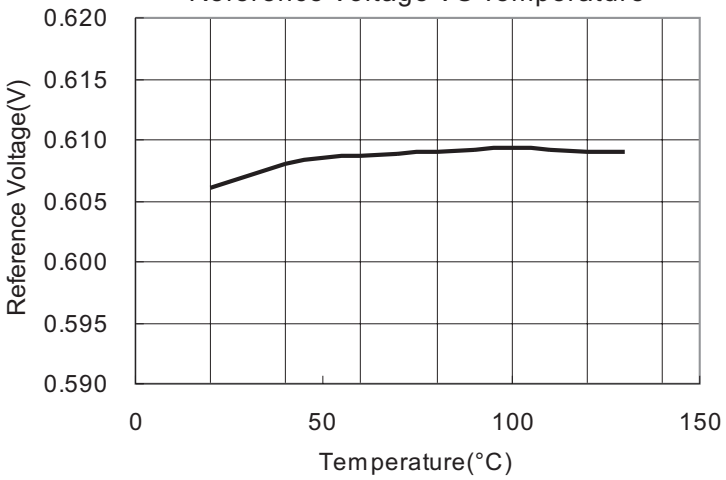
Reference Voltage VS Input Voltage



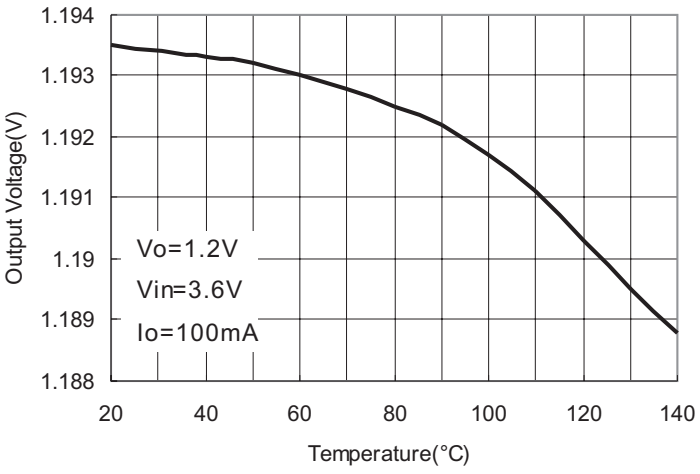
Output Voltage VS Load Current



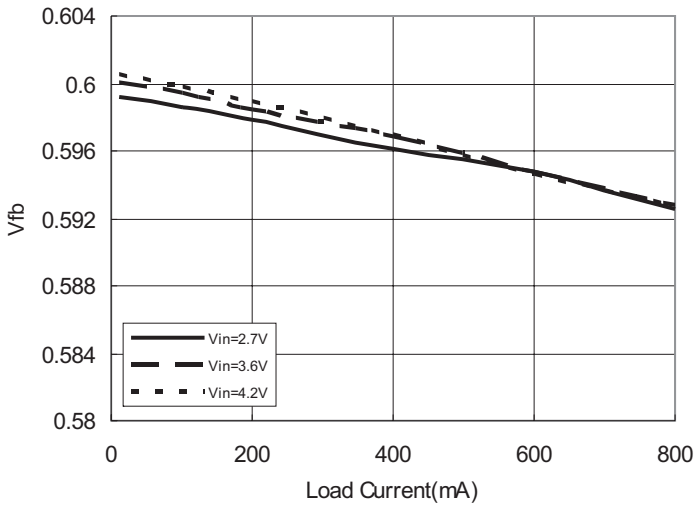
Reference Voltage VS Temperature



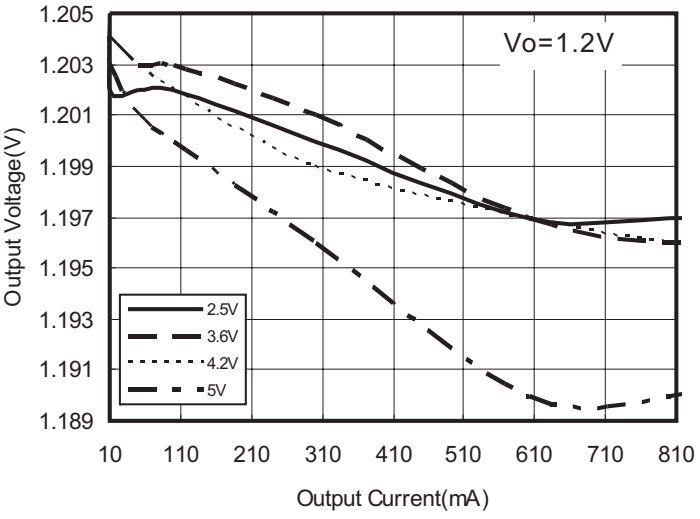
Output Voltage VS Temperature



Reference Voltage VS Load Current



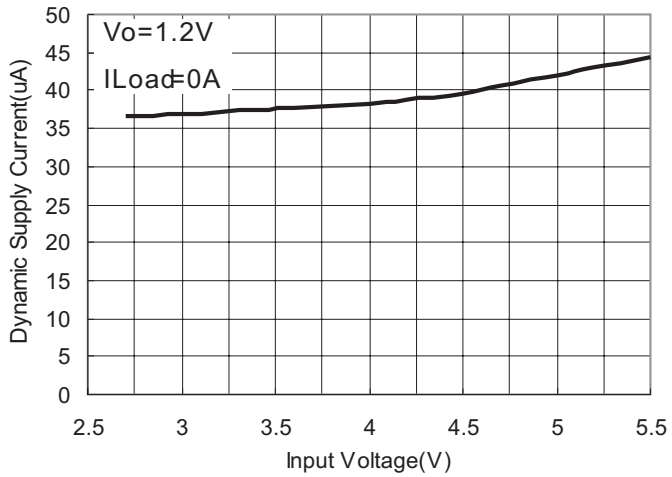
Output Voltage VS Output Current



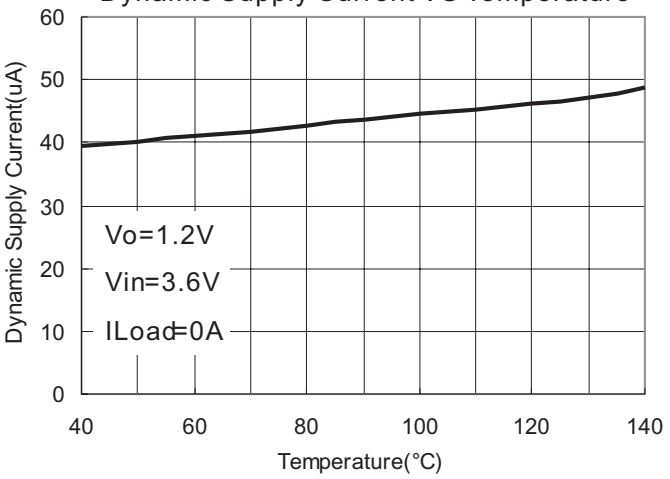
Typical Performance Characteristics

T_A=25°C, C_{IN}=10µF, C_O=10uF,L=4.7µH, unless otherwise noted.

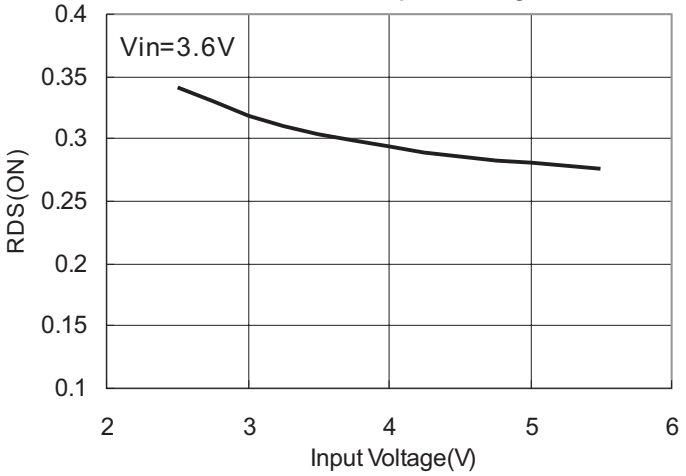
Dynamic Supply Current VS Input Voltage



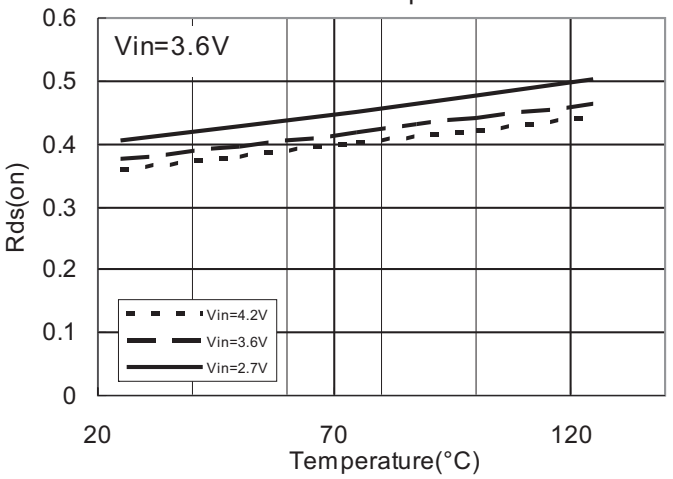
Dynamic Supply Current VS Temperature



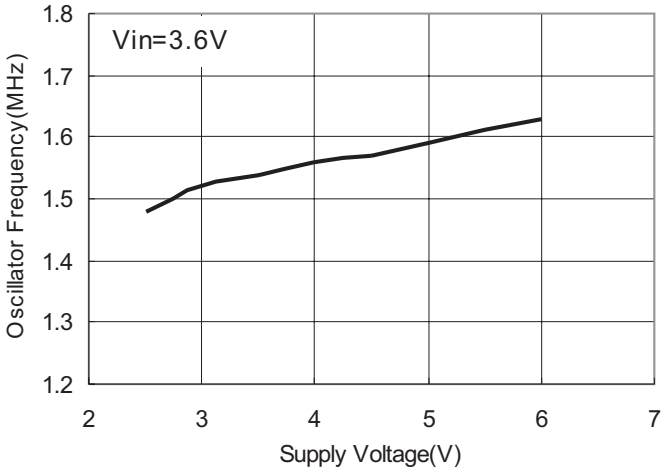
Rdson VS Input Voltage



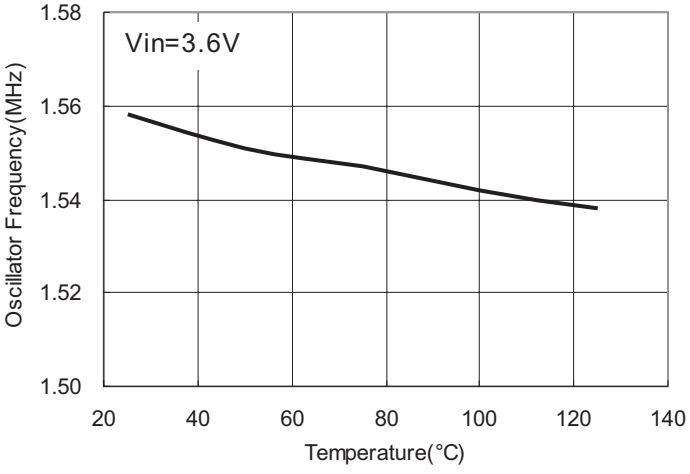
Rdson VS Temperature



Oscillator Frequency VS Supply Voltage



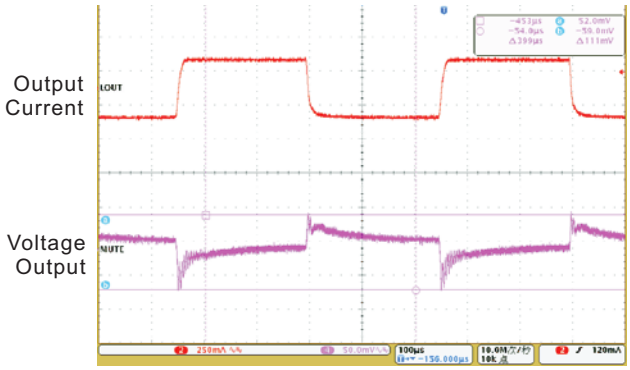
Oscillator Frequency VS Temperature



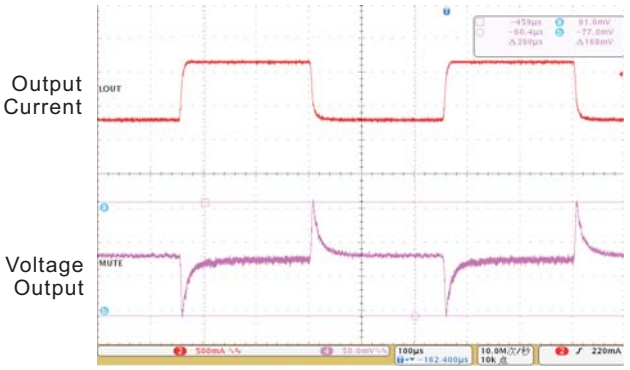
Typical Performance Characteristics

T_A=25°C,C_{IN}=10μF, C_O=10uF,L=4.7μH, unless otherwise noted.

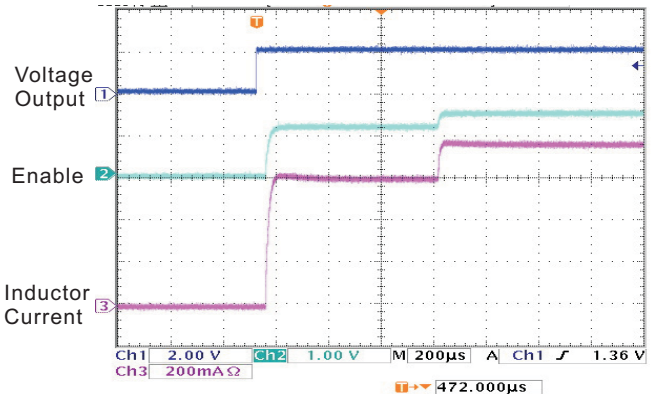
Load Transient
Io=0-500mA Vo=3.3V Vin=5V



Load Transient
Io=0-1A Vo=1.2V Vin=3.6V



Start-up from Shutdown
Vo=1.8V,Vin=3.6V



Application Information

The basic PAM2305 application circuit is shown in Page 1. External component selection is determined by the load requirement, selecting L first and then Cin and Cout.

Inductor Selection

For most applications, the value of the inductor will fall in the range of 1μH to 4.7μH. Its value is chosen based on the desired ripple current. Large value inductors lower ripple current and small value inductors result in higher ripple currents. Higher V_{IN} or Vout also increases the ripple current as shown in equation 1. A reasonable starting point for setting ripple current is $\triangle I_L$ = 400mA (40% of 1A).

$$\Delta I_L = \frac{1}{(f)(L)} V_{OUT}\left(1-\frac{V_{OUT}}{V_{IN}}\right) \qquad (1)$$

The DC current rating of the inductor should be at least equal to the maximum load current plus half the ripple current to prevent core saturation. Thus, a 1.4A rated inductor should be enough for most applications (1A + 400mA). For better efficiency, choose a low DC-resistance inductor.

Vo	1.2V	1.5V	1.8V	2.5V	3.3V
L	2.2μH	2.2μH	2.2μH	4.7μH	4.7μH

C_{IN} and C_{OUT} Selection

In continuous mode, the source current of the top MOSFET is a square wave of duty cycle Vout/Vin. To prevent large voltage transients, a low ESR input capacitor sized for the maximum RMS current must be used. The maximum RMS capacitor current is given by:

$$C_{IN} \text{ required } I_{RMS} \cong I_{OMAX} \frac{\left[V_{OUT}\left(V_{IN}-V_{OUT}\right)\right]^{1/2}}{V_{IN}}$$

This formula has a maximum at V_{IN} =2Vout, where $I_{RMS}=I_{OUT}/2$. This simple worst-case condition is commonly used for design because even significant deviations do not offer much relief. Note that the capacitor manufacturer's ripple current ratings are often based on 2000 hours of life. This makes it advisable to further derate the capacitor, or choose a capacitor rated at a higher temperature than required. Consult the manufacturer if there is any question.

The selection of Cout is driven by the required effective series resistance (ESR).

Typically, once the ESR requirement for Cout has been met, the RMS current rating generally far exceeds the I_{RIPPLE}(P-P) requirement. The output ripple △Vout is determined by:

$$\triangle V_{OUT} \cong \triangle I_L\left(ESR+\frac{1}{8fC_{OUT}}\right)$$

Where f = operating frequency, C_{OUT}=output capacitance and ΔI_L = ripple current in the inductor. For a fixed output voltage, the output ripple is highest at maximum input voltage since ΔI_L increases with input voltage.

Using Ceramic Input and Output Capacitors

Higher values, lower cost ceramic capacitors are now becoming available in smaller case sizes. Their high ripple current, high voltage rating and low ESR make them ideal for switching regulator applications. Using ceramic capacitors can achieve very low output ripple and small circuit size.

When choosing the input and output ceramic capacitors, choose the X5R or X7R dielectric formulations. These dielectrics have the best temperature and voltage characteristics of all the ceramics for a given value and size.

Thermal consideration

Thermal protection limits power dissipation in the PAM2305. When the junction temperature exceeds 150°C, the OTP (Over Temperature Protection) starts the thermal shutdown and turns the pass transistor off. The pass transistor resumes operation after the junction temperature drops below 120°C.

For continuous operation, the junction temperature should be maintained below 125°C. The power dissipation is defined as:

$$P_D = I_O^2 \frac{V_O R_{DSONH} + (V_{IN}-V_O) R_{DSONL}}{V_{IN}} + (t_{SW} F_S I_O + I_Q) V_{IN}$$

I_Q is the step-down converter quiescent current. The term tsw is used to estimate the full load step-down converter switching losses.

For the condition where the step-down converter is in dropout at 100% duty cycle, the total device dissipation reduces to:

$$P_D = I_O^2 R_{DSONH} + I_Q V_{IN}$$

Since $R_{DS(ON)}$, quiescent current, and switching losses all vary with input voltage, the total losses should be investigated over the complete input voltage range. The maximum power dissipation depends on the thermal resistance of IC package, PCB layout, the rate of surrounding airflow and temperature difference between junction and ambient. The maximum power dissipation can be calculated by the following formula:

$$P_D = \frac{T_{J(MAX)} - T_A}{\theta_{JA}}$$

Where TJ(max) is the maximum allowable junction temperature 125°C.T_A is the ambient temperature and θ_{JA} is the thermal resistance from the junction to the ambient. Based on the standard JEDEC for a two layers thermal test board, the thermal resistance θ_{JA} of SOT23-5 package is 250°C/W, DFN2X2 102°C/W, and QFN3X3 68°C/W, respectively. The maximum power dissipation at T_A = 25°C can be calculated by following formula:

SOT-25 package:

P_D=(125°C-25°C)/250°C/W=0.4W

DFN2*2 package:

P_D=(125°C-25°C)/102°C/W=0.984W

QFN3*3 package:

P_D=(125°C-25°C)/68°C/W=1.47W

Setting the Output Voltage

The internal reference is 0.6V (Typical). The output voltage is calculated as below:

$$V_O = 0.6 \times \left(1 + \frac{R1}{R2}\right)$$

The output voltage is given by Table 1.

Table 1: Resistor selection for output voltage setting

Vo	R1	R2
1.2V	100k	100k
1.5V	150k	100k
1.8V	200k	100k
2.5V	380k	120k
3.3V	540k	120k

100% Duty Cycle Operation

As the input voltage approaches the output voltage, the converter turns the P-channel transistor continuously on. In this mode the output voltage is equal to the input voltage minus the voltage drop across the P - channel transistor:

$$V_{OUT} = V_{IN} - I_{LOAD} (R_{dson} + R_L)$$

where R_{dson} = P-channel switch ON resistance, I_{LOAD} = Output current, R_L = Inductor DC resistance

UVLO and Soft-Start

The reference and the circuit remain reset until the VIN crosses its UVLO threshold.

The PAM2305 has an internal soft-start circuit that limits the in-rush current during start-up. This prevents possible voltage drops of the input voltage and eliminates the output voltage overshoot. The soft-start acts as a digital circuit to increase the switch current in several steps to the P-channel current limit (1500mA).

Short Circuit Protection

The switch peak current is limited cycle-by-cycle to a typical value of 1500mA. In the event of an output voltage short circuit, the device operates with a frequency of 400kHz and minimum duty cycle, therefore the average input current is typically 200mA.

Thermal Shutdown

When the die temperature exceeds 150°C, a reset occurs and the reset remains until the temperature decrease to 120°C, at which time the circuit can be restarted.

PCB Layout Check List

When laying out the printed circuit board, the following checklist should be used to ensure proper operation of the PAM2305. These items are also illustrated graphically in Figure 1. Check the following in your layout:

1. The power traces, consisting of the GND trace, the SW trace and the VIN trace should be kept short, direct and wide.
2. Does the V_{FB} pin connect directly to the feedback resistors? The resistive divider R1/R2 must be connected between the (+) plate of C_{OUT} and ground.
3. Does the (+) plate of CIN connect to VIN as closely as possible? This capacitor provides the AC current to the internal power MOSFETs.
4. Keep the switching node, SW, away from the sensitive VFB node.
5. Keep the (–) plates of C_{IN} and C_{OUT} as close as possible.

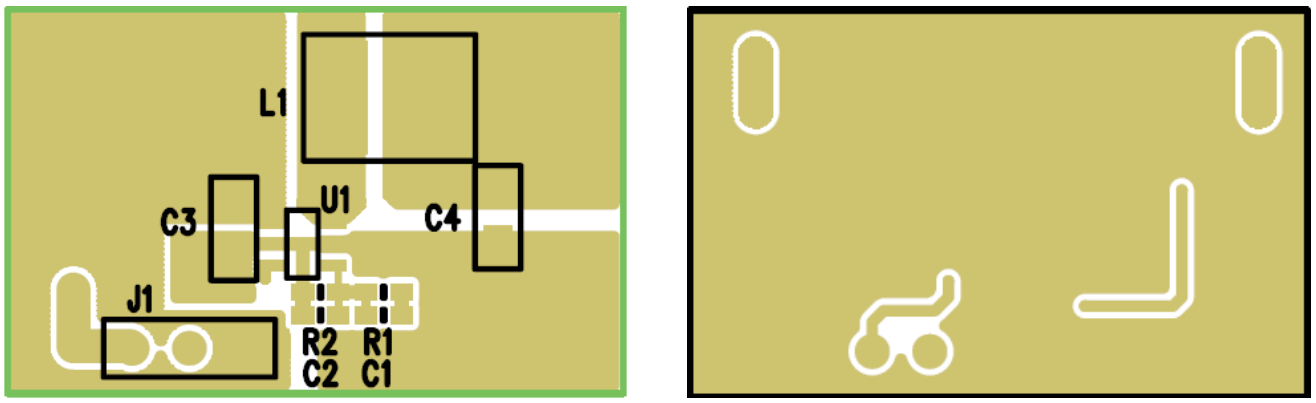
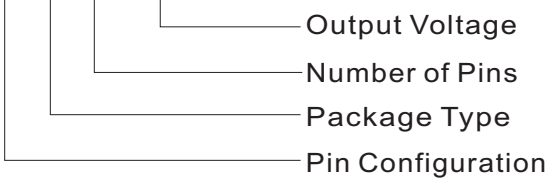


Figure 1 :PAM2305 Suggested Layout

Ordering Information

PAM 2305 X X X xxx



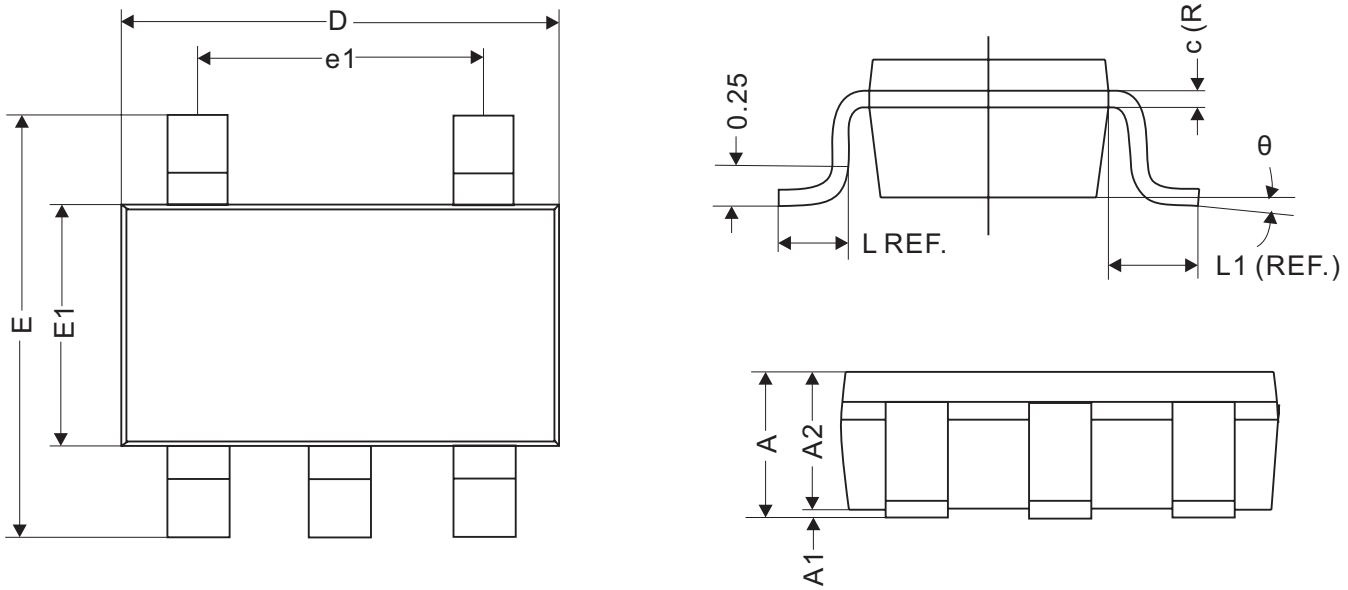
Pin Configuration	Package Type	Number of Pins	Output Voltage
A Type	A: SOT-23	B: 5	330: 3.3V
1. VIN	J: QFN 3x3	E: 16	280: 2.8V
2. GND	G: DFN 2x2	F: 6	250: 2.5V
3. EN			180: 1.8V
4. VOUT/FB			150: 1.5V
5. SW			120: 1.2V
B Type :			ADJ: Adjustable
16 pins			
C Type:			
1. NC			
2. EN			
3. VIN			
4. SW			
5. GND			
6 : VOUT/FB			

Ordering Information

Part Number	Output Voltage	Marking	Package Type	Standard Package
PAM2305AAB330	3.3V	BEKYW	SOT23-5	3,000Units/Tape&Reel
PAM2305AAB280	2.8V	BEHYW	SOT23-5	3,000Units/Tape&Reel
PAM2305AAB250	2.5V	BEGYW	SOT23-5	3,000Units/Tape&Reel
PAM2305AAB180	1.8V	BEEYW	SOT23-5	3,000Units/Tape&Reel
PAM2305AAB150	1.5V	BECYW	SOT23-5	3,000Units/Tape&Reel
PAM2305AAB120	1.2V	BEBYW	SOT23-5	3,000Units/Tape&Reel
PAM2305AABADJ	ADJ	BEAYW	SOT23-5	3,000Units/Tape&Reel
PAM2305BJE330	3.3V	P2305K	QFN3x3	3,000Units/Tape&Reel
PAM2305BJE280	2.8V	P2305H	QFN3x3	3,000Units/Tape&Reel
PAM2305BJE250	2.5V	P2305G	QFN3x3	3,000Units/Tape&Reel
PAM2305BJE180	1.8V	P2305E	QFN3x3	3,000Units/Tape&Reel
PAM2305BJE150	1.5V	P2305C	QFN3x3	3,000Units/Tape&Reel
PAM2305BJE120	1.2V	P2305B	QFN3x3	3,000Units/Tape&Reel
PAM2305BJEADJ	ADJ	P2305A	QFN3x3	3,000Units/Tape&Reel
PAM2305CGF330	3.3V	BEKYW	DFN2x2-6	3,000Units/Tape&Reel
PAM2305CGF280	2.8V	BEHYW	DFN2x2-6	3,000Units/Tape&Reel
PAM2305CGF250	2.5V	BEGYW	DFN2x2-6	3,000Units/Tape&Reel
PAM2305CGF180	1.8V	BEEYW	DFN2x2-6	3,000Units/Tape&Reel
PAM2305CGF150	1.5V	BECYW	DFN2x2-6	3,000Units/Tape&Reel
PAM2305CGF120	1.2V	BEBYW	DFN2x2-6	3,000Units/Tape&Reel
PAM2305CGFADJ	ADJ	BEAYW	DFN2x2-6	3,000Units/Tape&Reel

Outline Dimensions

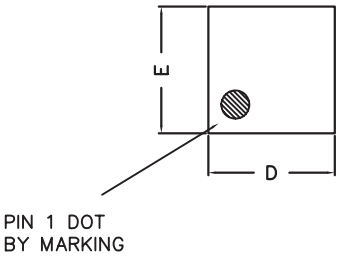
SOT23-5



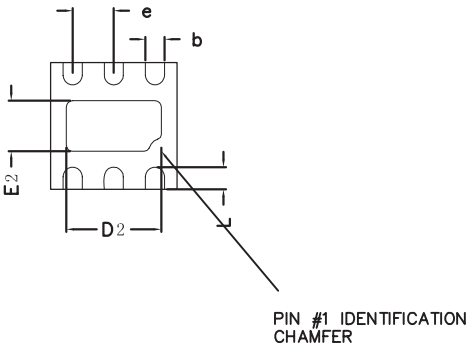
REF.	Millimeter		
	Min	Nom	Max
A		1.10MAX	
A1	0	0.05	0.10
A2	0.70	1.00	1.295
c		0.12REF.	
D	2.70	2.90	3.10
E	2.60	2.80	3.00
E1	1.40	1.60	1.80
L		0.45REF.	
L1		0.60REF.	
θ	0°	5°	10°
b	0.30	0.40	0.50
e		0.95REF.	
e1		1.90REF.	

Outline Dimensions

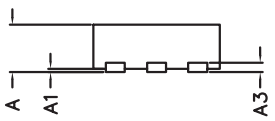
DFN 2x2



TOP VIEW



BOTTOM VIEW

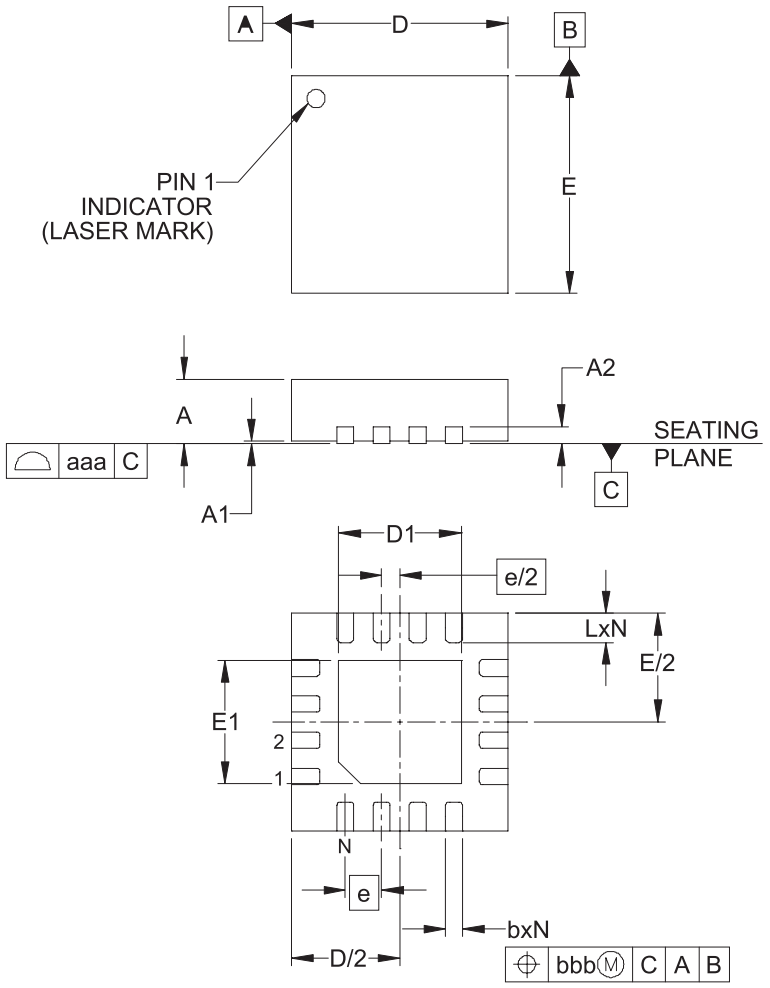


SIDE VIEW

COMMON DIMENSIONS(MM)			
PKG.	W: VERY VERY THIN		
REF.	MIN.	NOM.	MAX
A	0.70	0.75	0.80
A1	0.00	–	0.05
A3	0.2 REF.		
D	1.95	2.00	2.05
E	1.95	2.00	2.05
b	0.25	0.30	0.35
L	0.25	0.35	0.45
D2	1.35	1.50	1.60
E2	0.65	0.80	0.90
e	0.65 BSC		

Outline Dimensions

3x3 mm QFN 16



DIMENSIONS (Millieters)			
	MIN	TYP	MAX
A	0.70	0.75	0.80
A1	0.00	0.02	0.05
A2		0.20	
b	0.18	0.25	0.30
D	2.90	3.00	3.10
D1	1.55	1.70	1.80
E	2.90	3.00	3.10
E1	1.55	1.70	1.80
e		0.50BSC	
L	0.30	0.40	0.50
N		16	
aaa		0.08	
bbb		0.10	

NOTES:

1. CONTROLLING DIMENSIONS ARE IN MILLIMETERS (ANGLES IN DEGREES).
2. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.
3. DAP IS 1.90 x 1.90mm.